

Electronic Patent Application Fee Transmittal

Application Number:	10771243			
Filing Date:	03-Feb-2004			
Title of Invention:	Stacked die module and techniques for forming a stacked die module			
First Named Inventor/Applicant Name:	Chad A. Cobbley			
Filer:	Robert A. Manware/Leah Espinosa			
Attorney Docket Number:	MICS:0078-4			
Filed as Large Entity				
Utility Filing Fees				
Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Basic Filing:				
Pages:				
Claims:				
Miscellaneous-Filing:				
Petition:				
Patent-Appeals-and-Interference:				
Post-Allowance-and-Post-Issuance:				
Extension-of-Time:				

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Miscellaneous:				
Submission- Information Disclosure Stmt	1806	1	180	180
Total in USD (\$)				180